

IRGP8B120KD-E

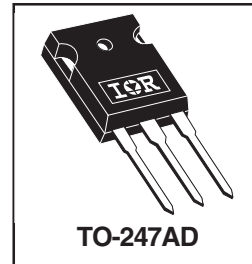
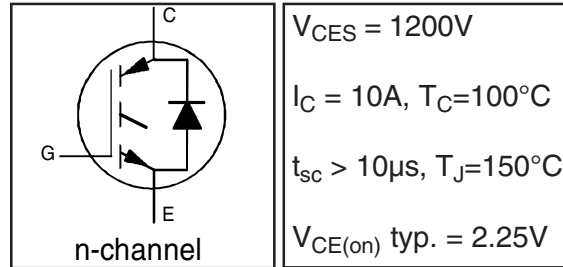
INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Features

- Low VCE (on) Non Punch Through IGBT Technology.
- Low Diode VF.
- 10µs Short Circuit Capability.
- Square RBSOA.
- Ultrasoft Diode Reverse Recovery Characteristics.
- Positive VCE (on) Temperature Coefficient.
- TO-247AD Package.

Benefits

- Benchmark Efficiency for Motor Control.
- Rugged Transient Performance.
- Low EMI.
- Excellent Current Sharing in Parallel Operation.



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	20	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	10	
I_{CM}	Pulse Collector Current	40	
I_{LM}	Clamped Inductive Load current ①	40	
$I_F @ T_C = 25^\circ C$	Diode Continuous Forward Current	20	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	10	
I_{FM}	Diode Maximum Forward Current	40	
V_{GE}	Gate-to-Emitter Voltage	±20	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	135	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	54	
T_J	Operating Junction and	-55 to +150	°C
T_{STG}	Storage Temperature Range		
	Storage Temperature Range, for 10 sec.		
	Mounting Torque, 6-32 or M3 Screw	10 lbf•in (1.1N•m)	

Thermal and Mechanical Characteristics

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case- IGBT	—	—	0.92	°C/W
$R_{\theta JC}$	Junction-to-Case- Diode	—	—	1.58	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref. Fig.
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage	1200	—	—	V	V _{GE} = 0V, I _C = 500μA	
ΔV _{(BR)CES} /ΔT _J	Temperature Coeff. of Breakdown Voltage	—	1.15	—	V/°C	V _{GE} = 0V, I _C = 1.0mA, (25°C-125°C)	
V _{CE(on)}	Collector-to-Emitter Saturation Voltage	—	2.25	2.45	V	I _C = 8.0A, V _{GE} = 15V	5,6,7
		—	2.65	2.85		I _C = 8.0A, V _{GE} = 15V, T _J = 125°C	9,10,11
V _{GE(th)}	Gate Threshold Voltage	4.0	5.0	6.0	V	V _{CE} = V _{GE} , I _C = 250μA	9,10,11
ΔV _{GE(th)} /ΔT _J	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/°C	V _{CE} = V _{GE} , I _C = 1.0mA, (25°C-125°C)	12
g _{fe}	Forward Transconductance	—	5.2	—	S	V _{CE} = 50V, I _C = 8.0A, PW=80μs	
I _{CES}	Zero Gate Voltage Collector Current	—	5.0	100	μA	V _{GE} = 0V, V _{CE} = 1200V	
		—	125	300		V _{GE} = 0V, V _{CE} = 1200V, T _J = 125°C	
V _{FM}	Diode Forward Voltage Drop	—	1.85	2.10	V	I _F = 8.0A	8
		—	1.95	2.20		I _F = 8.0A T _J = 125°C	
I _{GES}	Gate-to-Emitter Leakage Current	—	—	±100	nA	V _{GE} = ±20V	

Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref. Fig.
Q _g	Total Gate Charge (turn-on)	—	50	75	nC	I _C = 8.0A	23
Q _{ge}	Gate - Emitter Charge (turn-on)	—	6.0	8.0		V _{CC} = 800V	CT 1
Q _{gc}	Gate - Collector Charge (turn-on)	—	25	38		V _{GE} = 15V	
E _{on}	Turn-On Switching Loss	—	325	450	μJ	I _C = 8.0A, V _{CC} = 600V	CT 4
E _{off}	Turn-Off Switching Loss	—	525	700		V _{GE} = 15V, R _G = 22Ω, L = 1.0mH	
E _{tot}	Total Switching Loss	—	850	1150		L _s = 150nH T _J = 25°C ⊙	
t _{d(on)}	Turn-On Delay Time	—	30	39	ns	I _C = 8.0A, V _{CC} = 600V	CT 4
t _r	Rise Time	—	15	21		V _{GE} = 15V, R _G = 22Ω L = 1.0mH	
t _{d(off)}	Turn-Off Delay Time	—	165	180		L _s = 150nH, T _J = 25°C	
t _f	Fall Time	—	33	43			
E _{on}	Turn-On Switching Loss	—	525	675		I _C = 8.0A, V _{CC} = 600V	
E _{off}	Turn-Off Switching Loss	—	725	975	μJ	V _{GE} = 15V, R _G = 22Ω, L = 1.0mH	13,15
E _{tot}	Total Switching Loss	—	1250	1650		L _s = 150nH T _J = 125°C ⊙	WF, WF 2
t _{d(on)}	Turn-On Delay Time	—	30	39		I _C = 8.0A, V _{CC} = 600V	14, 16
t _r	Rise Time	—	15	21	ns	V _{GE} = 15V, R _G = 22Ω L = 1.0mH	CT 4
t _{d(off)}	Turn-Off Delay Time	—	195	210		L _s = 150nH, T _J = 125°C	WF 1
t _f	Fall Time	—	42	55			WF 2
C _{ies}	Input Capacitance	—	690	—	pF	V _{GE} = 0V	22
C _{oes}	Output Capacitance	—	45	—		V _{CC} = 30V	
C _{res}	Reverse Transfer Capacitance	—	22	—		f = 1.0MHz	
RBSOA	Reverse Bias Safe Operating Area	FULL SQUARE				T _J = 150°C, I _C = 40A, V _p = 1200V V _{CC} = 900V, V _{GE} = +15V to 0V, R _G = 22Ω	4 CT 2
SCSOA	Short Circuit Safe Operating Area	10	—	—	μs	T _J = 150°C, V _p = 1200V, R _G = 22Ω V _{CC} = 900V, V _{GE} = +15V to 0V	CT 3 WF 4
E _{rec}	Reverse Recovery energy of the diode	—	650	875	μJ	T _J = 125°C	17, 18, 19
t _{rr}	Diode Reverse Recovery time	—	95	112	ns	V _{CC} = 600V, I _F = 8.0A, L = 1.0mH	20, 21
I _{rr}	Diode Peak Reverse Recovery Current	—	16	20	A	V _{GE} = 15V, R _G = 22Ω, L _s = 150nH	CT 4, WF 3

⊙ V_{CC} = 80% (V_{CES}), V_{GE} = 15V, L = 100μH, R_G = 50Ω.

⊙ Energy losses include "tail" and diode reverse recovery.

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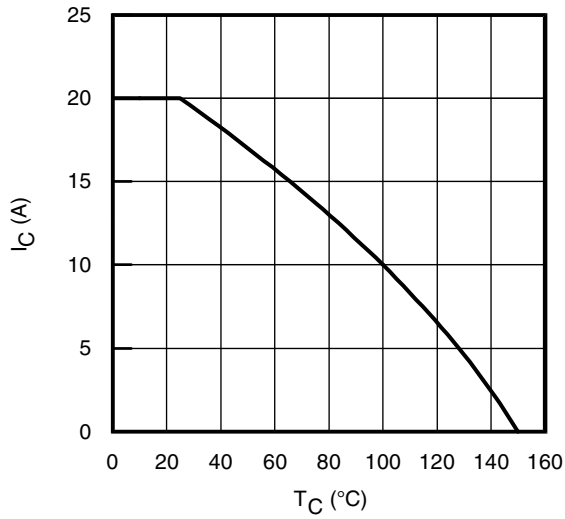


Fig. 1 - Maximum DC Collector Current vs. Case Temperature

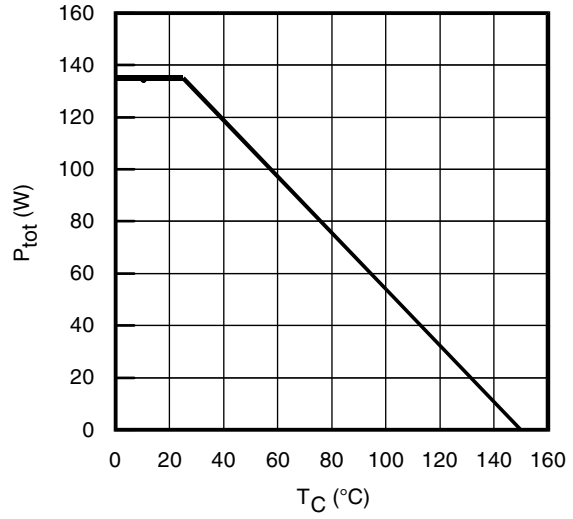


Fig. 2 - Power Dissipation vs. Case Temperature

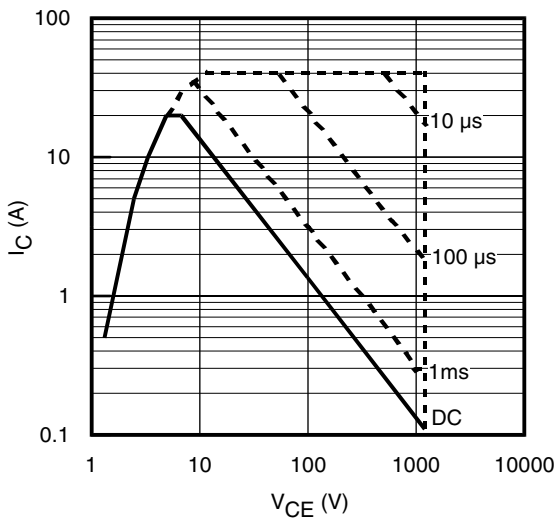


Fig. 3 - Forward SOA
 $T_C = 25^\circ\text{C}$; $T_J \leq 150^\circ\text{C}$

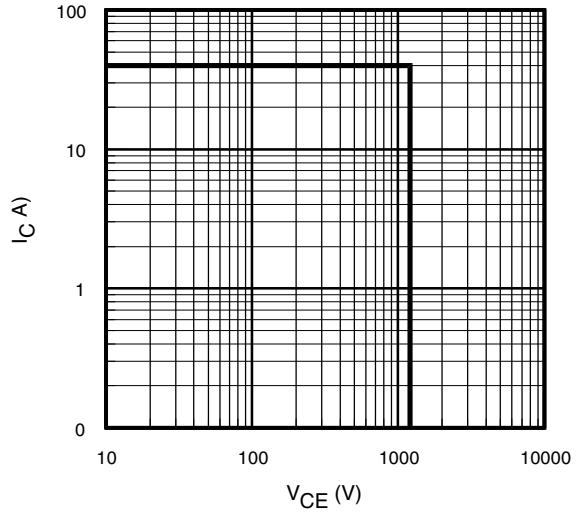


Fig. 4 - Reverse Bias SOA
 $T_J = 150^\circ\text{C}$; $V_{GE} = 15\text{V}$

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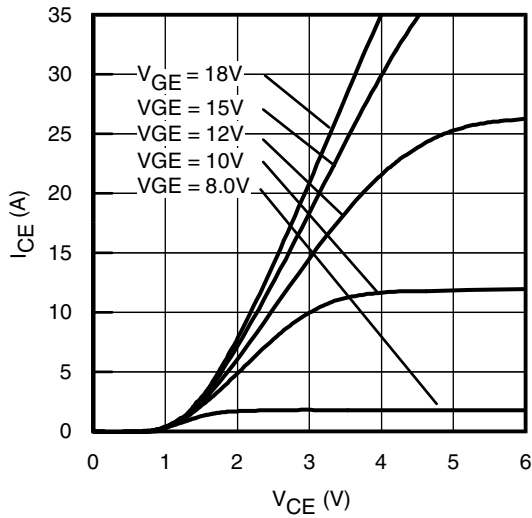


Fig. 5 - Typ. IGBT Output Characteristics
 $T_J = -40^{\circ}\text{C}$; $t_p = 80\mu\text{s}$

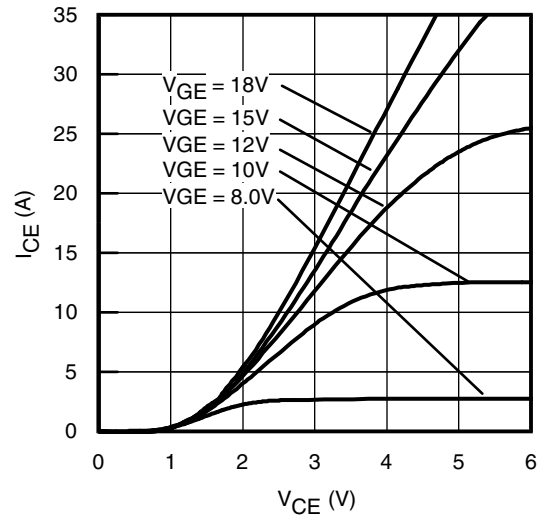


Fig. 6 - Typ. IGBT Output Characteristics
 $T_J = 25^{\circ}\text{C}$; $t_p = 80\mu\text{s}$

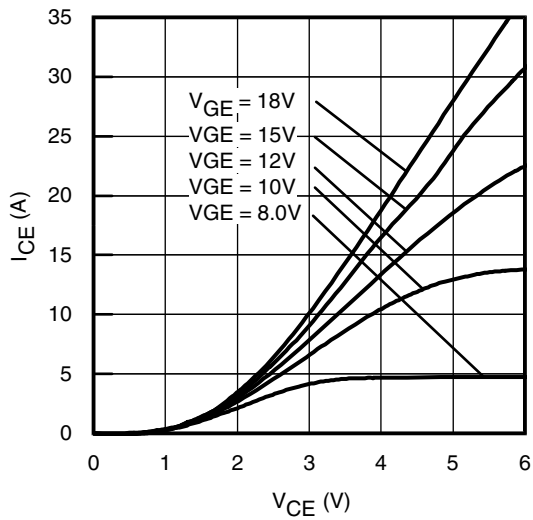


Fig. 7 - Typ. IGBT Output Characteristics
 $T_J = 125^{\circ}\text{C}$; $t_p = 80\mu\text{s}$

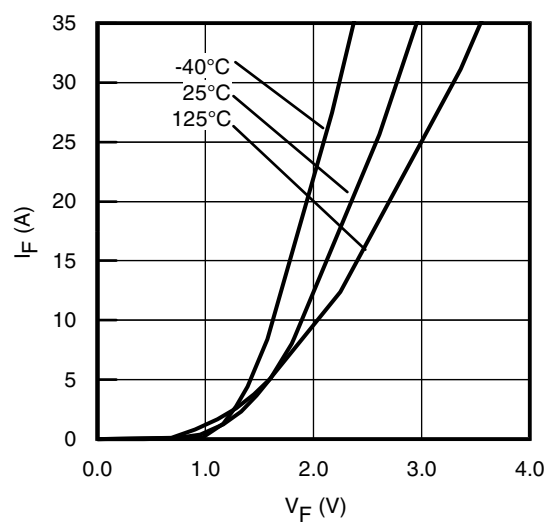


Fig. 8 - Typ. Diode Forward Characteristics
 $t_p = 80\mu\text{s}$

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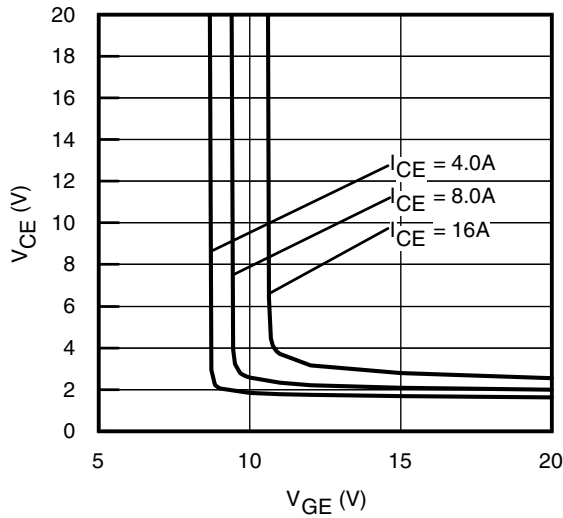


Fig. 9 - Typical V_{CE} vs. V_{GE}
 $T_J = -40^\circ\text{C}$

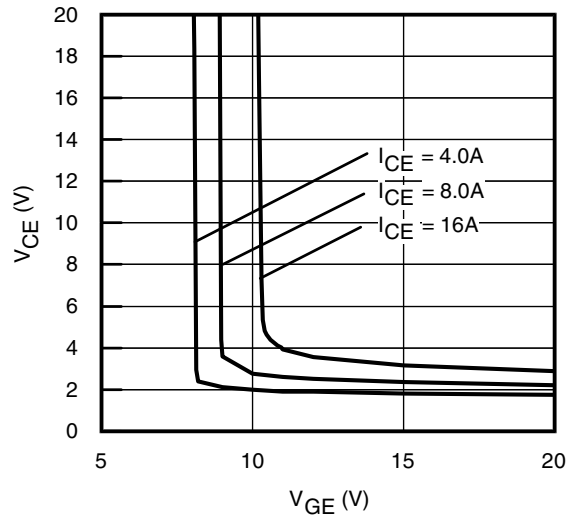


Fig. 10 - Typical V_{CE} vs. V_{GE}
 $T_J = 25^\circ\text{C}$

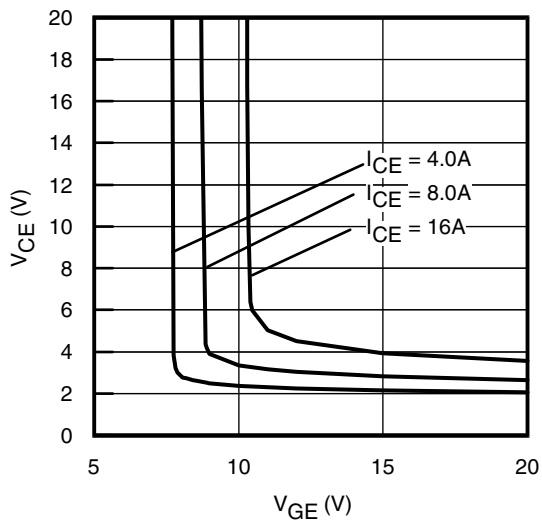


Fig. 11 - Typical V_{CE} vs. V_{GE}
 $T_J = 125^\circ\text{C}$

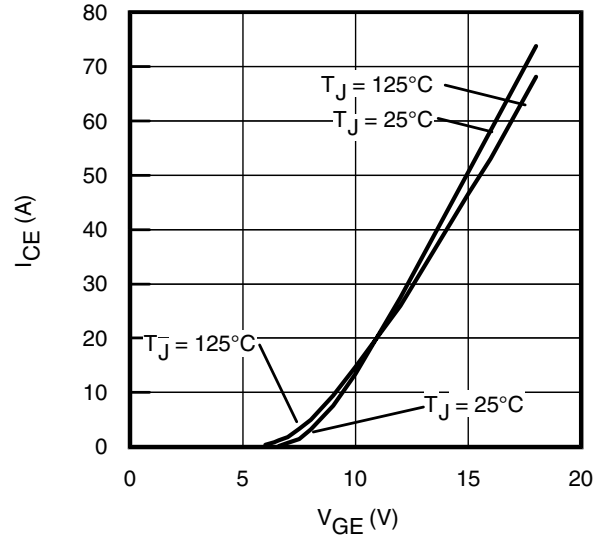


Fig. 12 - Typ. Transfer Characteristics
 $V_{CE} = 50\text{V}$; $t_p = 10\mu\text{s}$

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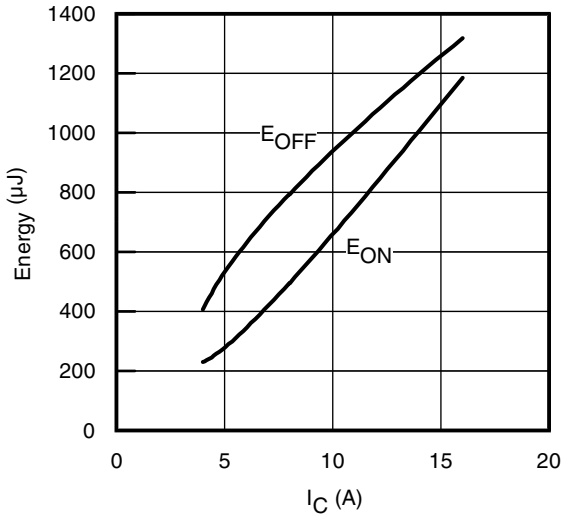


Fig. 13 - Typ. Energy Loss vs. I_C
 $T_J = 125^\circ\text{C}$; $L = 1.0\text{mH}$; $V_{CE} = 600\text{V}$
 $R_G = 22\Omega$; $V_{GE} = 15\text{V}$

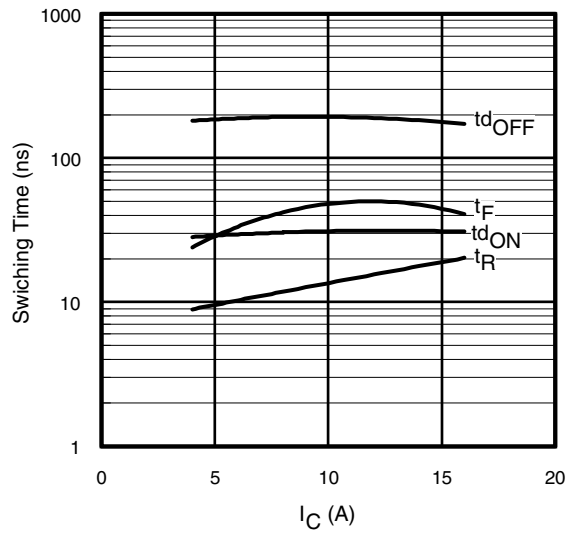


Fig. 14 - Typ. Switching Time vs. I_C
 $T_J = 125^\circ\text{C}$; $L = 1.0\text{mH}$; $V_{CE} = 600\text{V}$
 $R_G = 22\Omega$; $V_{GE} = 15\text{V}$

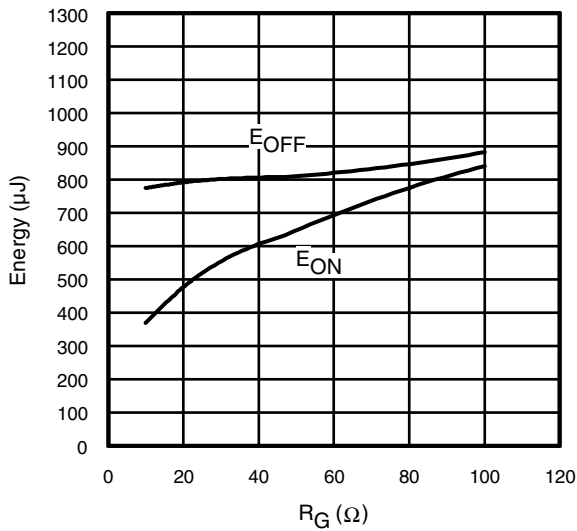


Fig. 15 - Typ. Energy Loss vs. R_G
 $T_J = 125^\circ\text{C}$; $L = 1.0\text{mH}$; $V_{CE} = 600\text{V}$
 $I_{CE} = 8.0\text{A}$; $V_{GE} = 15\text{V}$

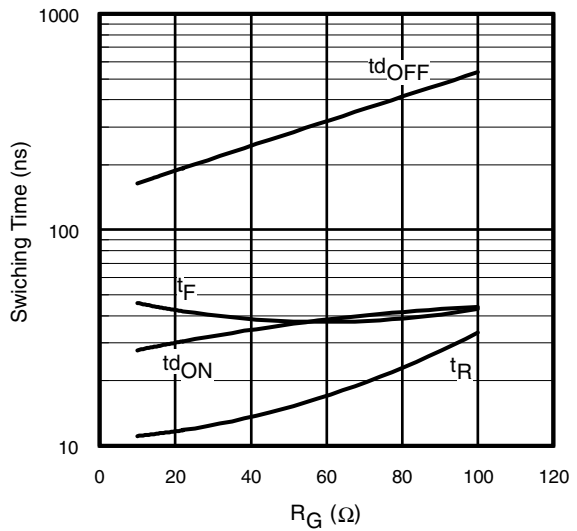


Fig. 16 - Typ. Switching Time vs. R_G
 $T_J = 125^\circ\text{C}$; $L = 1.0\text{mH}$; $V_{CE} = 600\text{V}$
 $I_{CE} = 8.0\text{A}$; $V_{GE} = 15\text{V}$

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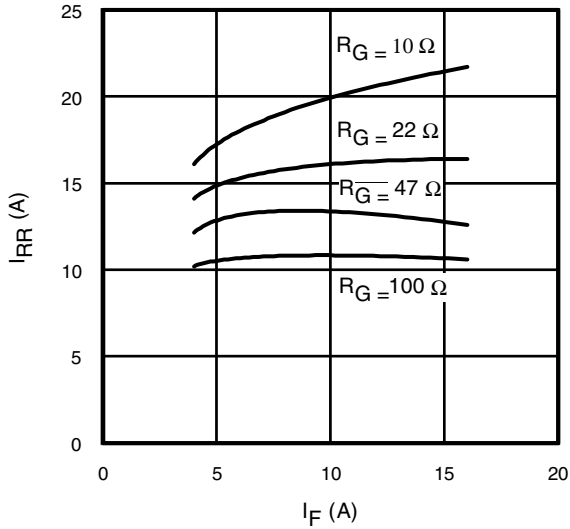


Fig. 17 - Typical Diode I_{RR} vs. I_F
 $T_J = 125^\circ\text{C}$

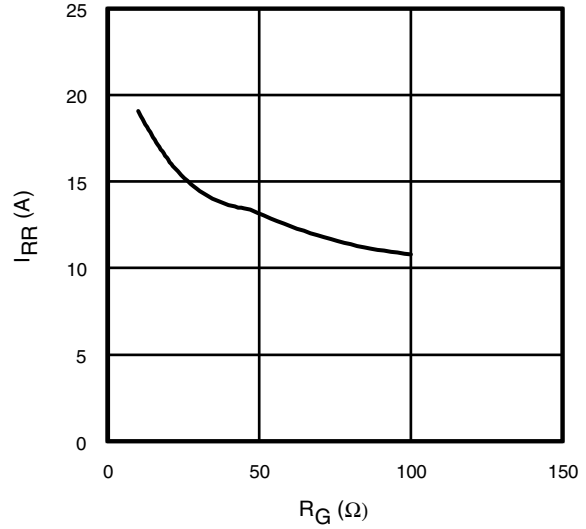


Fig. 18 - Typical Diode I_{RR} vs. R_G
 $T_J = 125^\circ\text{C}$; $I_F = 8.0\text{A}$

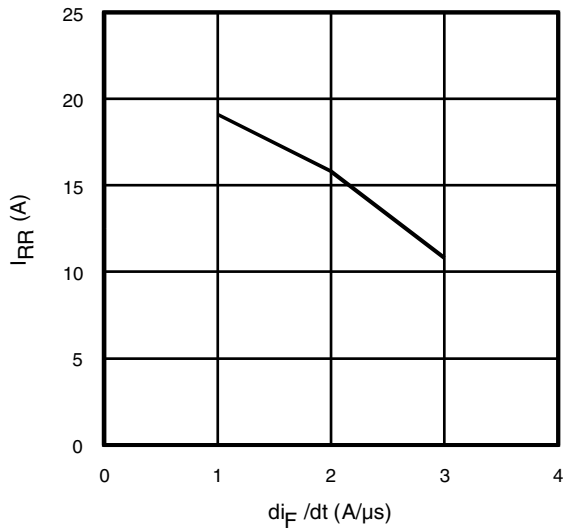


Fig. 19- Typical Diode I_{RR} vs. di_F/dt
 $V_{CC} = 600\text{V}$; $V_{GE} = 15\text{V}$;
 $I_F = 8.0\text{A}$; $T_J = 125^\circ\text{C}$

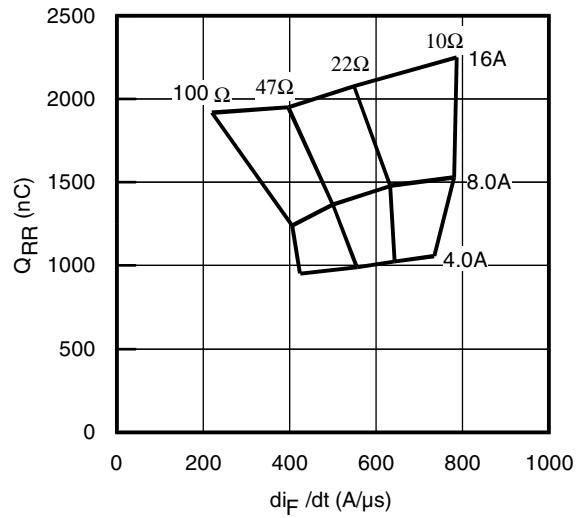


Fig. 20 - Typical Diode Q_{RR}
 $V_{CC} = 600\text{V}$; $V_{GE} = 15\text{V}$; $T_J = 125^\circ\text{C}$

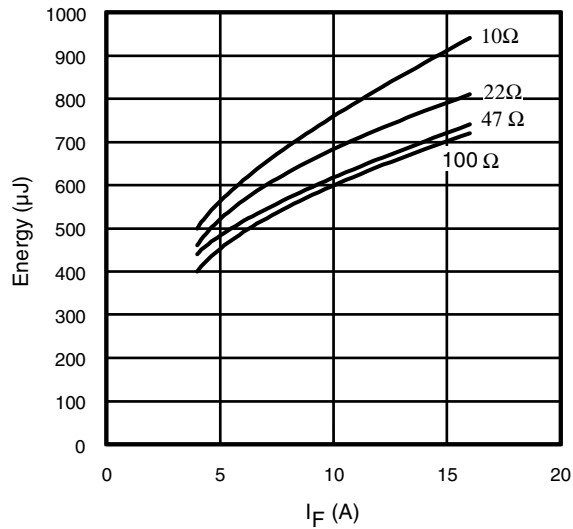


Fig. 21 - Typical Diode E_{RR} vs. I_F
 $T_J = 125^\circ\text{C}$

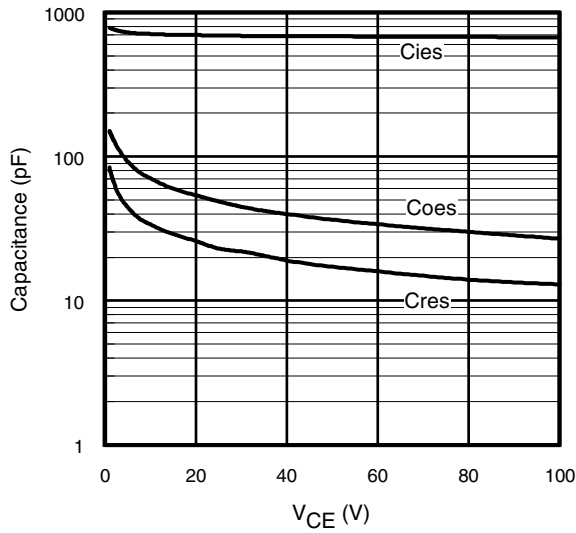


Fig. 22- Typ. Capacitance vs. V_{CE}
 $V_{GE} = 0\text{V}$; $f = 1\text{MHz}$

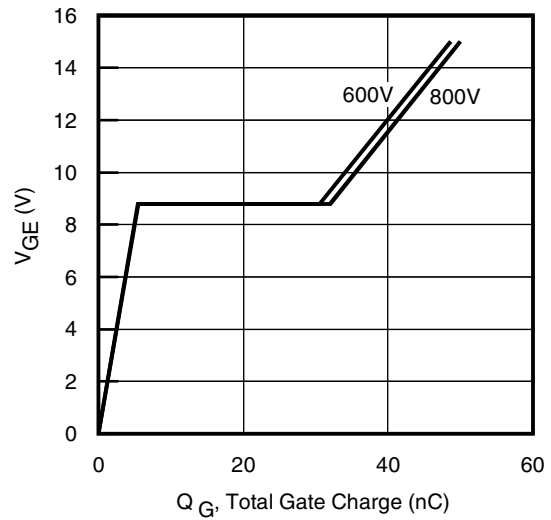


Fig. 23 - Typical Gate Charge vs. V_{GE}
 $I_{CE} = 8.0\text{A}$; $L = 600\mu\text{H}$

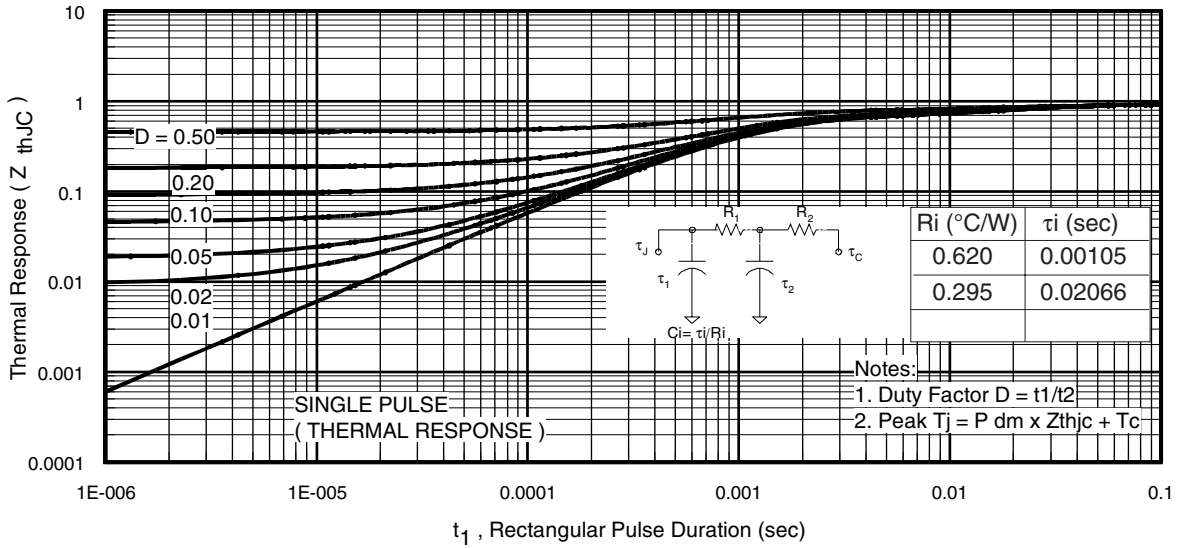


Fig 24. Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)

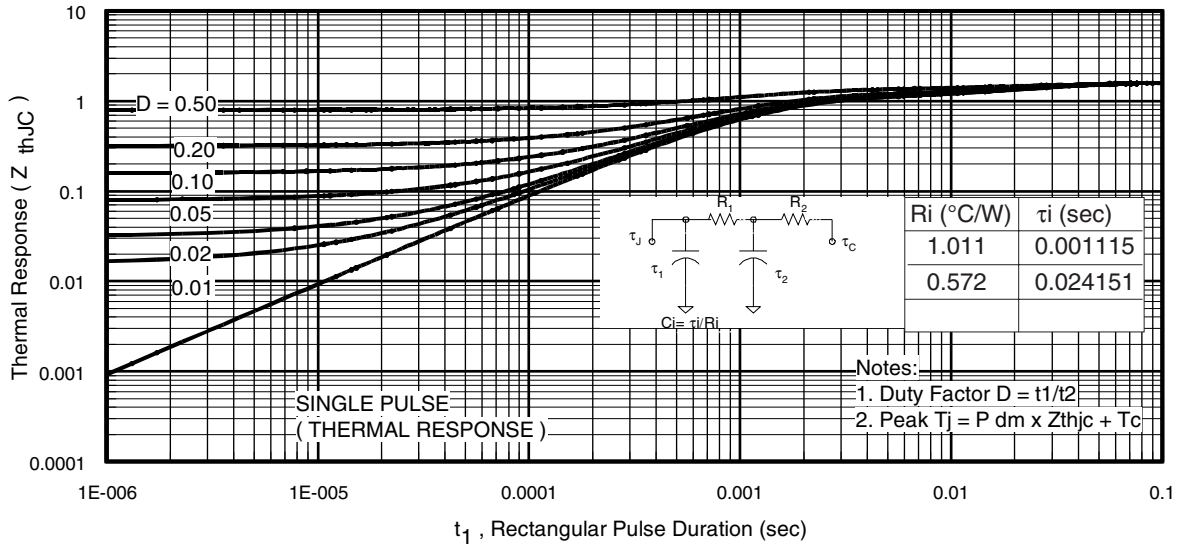


Fig 25. Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

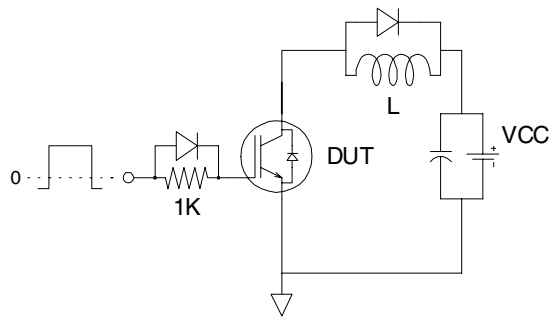


Fig.C.T.1 - Gate Charge Circuit (turn-off)

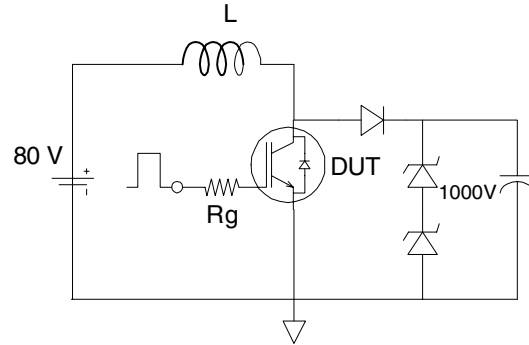


Fig.C.T.2 - RBSOA Circuit

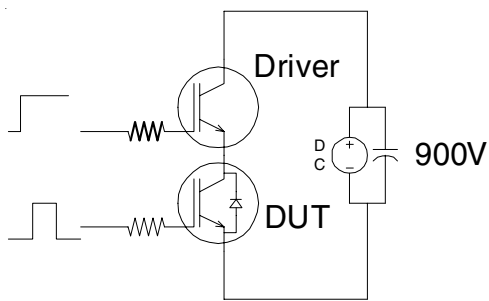


Fig.C.T.3 - S.C.SOA Circuit

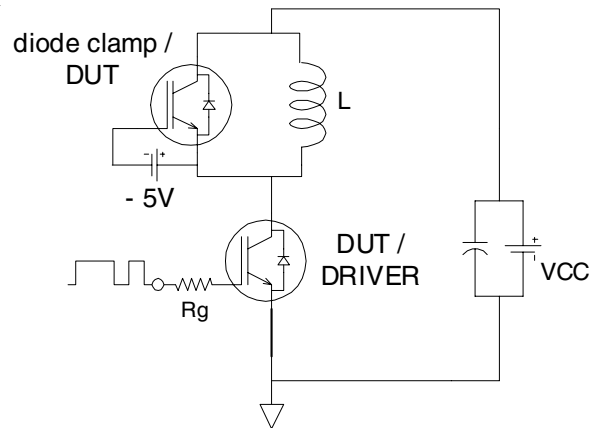


Fig.C.T.4 - Switching Loss Circuit

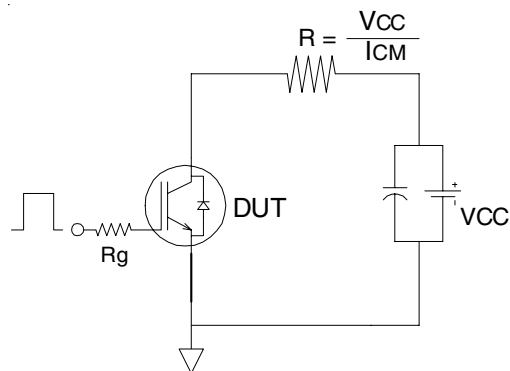


Fig.C.T.5 - Resistive Load Circuit

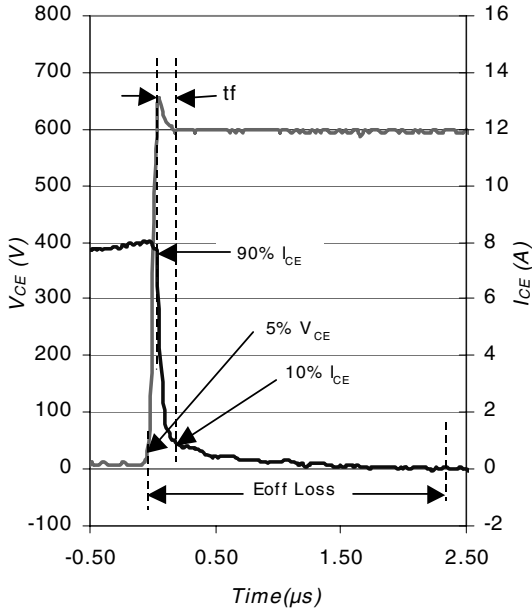


Fig. WF1- Typ. Turn-off Loss Waveform
@ $T_J = 125^\circ\text{C}$ using Fig. CT.4

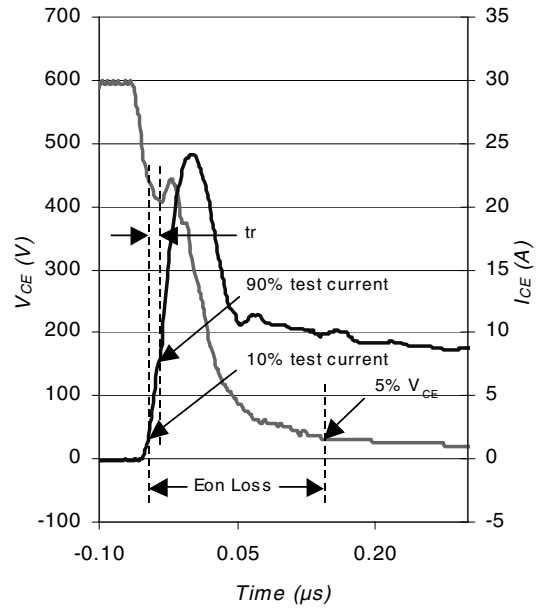


Fig. WF2- Typ. Turn-on Loss Waveform
@ $T_J = 125^\circ\text{C}$ using Fig. CT.4

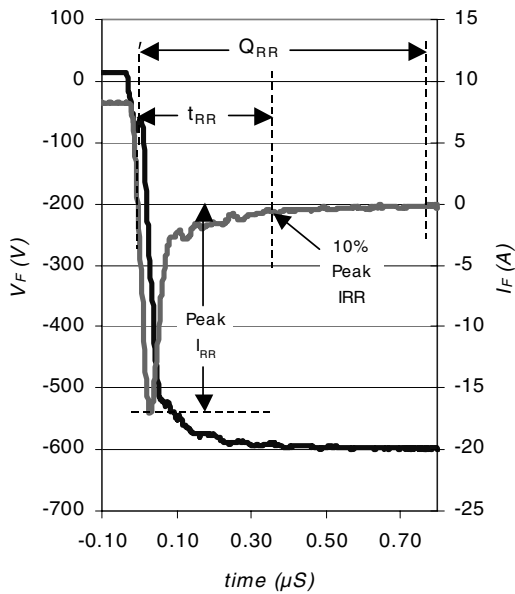


Fig. WF3- Typ. Diode Recovery Waveform
@ $T_J = 125^\circ\text{C}$ using Fig. CT.4

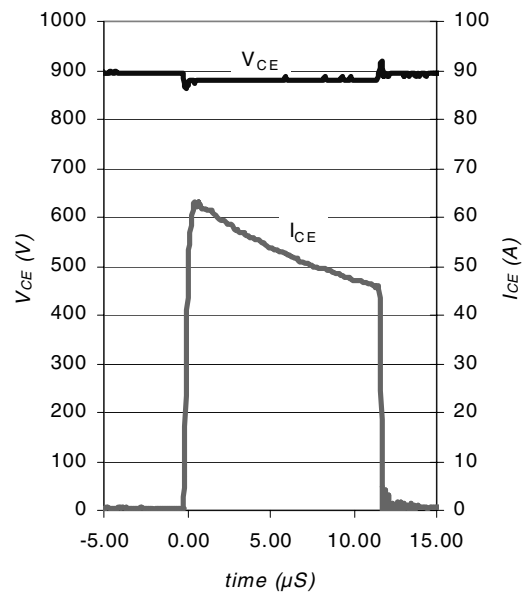
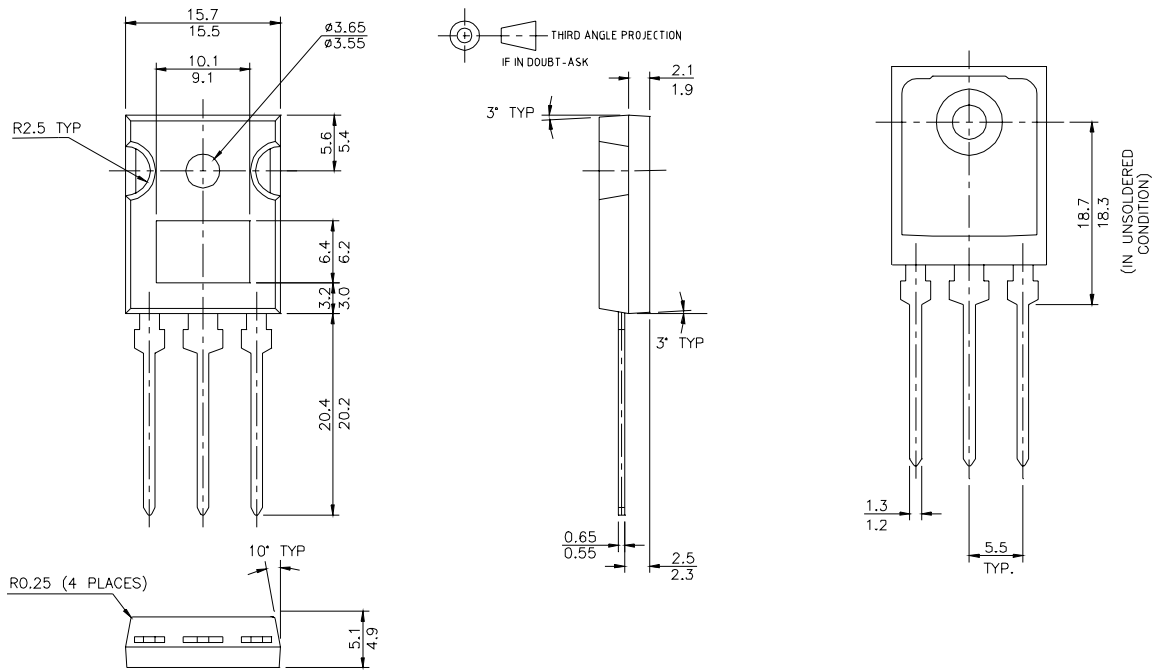


Fig. WF4- Typ. S.C Waveform
@ $T_C = 150^\circ\text{C}$ using Fig. CT.3

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TO-247AD Case Outline and Dimensions



TO-247 package is not recommended for Surface Mount Application.

Data and specifications subject to change without notice.
This product has been designed and qualified for Industrial market.
Qualification Standards can be found on IR's Web site.

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